



100V N-Channel Power MOSFET

Product Summary

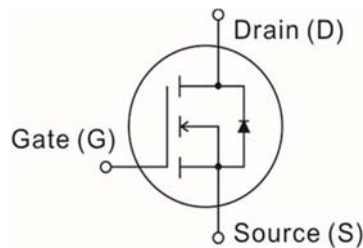
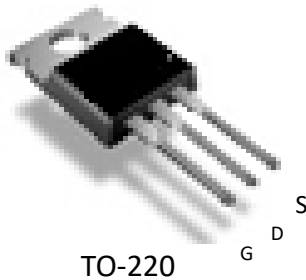
Parameter	Value	Unit
$V_{DS} @ T_{jmax}$	100	V
$R_{DS(on),max} @ V_{GS} = 10\text{ V}$	2.6	mΩ
$I_D @ V_{GS} = 10\text{ V}$	184	A
P_{tot}	250	W

Features

- * Low on-resistance
- * Low gate threshold voltage
- * Excellent FOM

Application

- * Synchronous rectification
- * BMS battery protection
- * DC/AC inverter
- * DC/DC converter



Maximum ratings $T_A = 25^\circ\text{C}$ unless otherwise noted				
Parameter		Symbol	Limit	Unit
Drain - source voltage		V_{DS}	100	V
Continuous drain current	$T_C @ 25^\circ\text{C}$	I_D	184	A
	$T_C @ 100^\circ\text{C}$		141	
Pulsed drain current tp limited by Tj max (Note 1)	$T_C @ 25^\circ\text{C}$	I_D pulsed	736	A
Single pulse avalanche energy (Note 2)		E_{AS}	627	mJ
Gate-source voltage		V_{GS}	± 20	V
Power dissipation	$T_C @ 25^\circ\text{C}$	P_{tot}	250	W
Storage temperature range		T_{STG}	- 55 to +175	$^\circ\text{C}$
Operating junction temperature range		T_j	- 55 to +175	$^\circ\text{C}$



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Electrical characteristics $T_A = 25^\circ\text{C}$ unless otherwise specified						
Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Off characteristics						
Drain-source breakdown voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	100	---	---	V
Gate-source leakage	$V_{GS} = \pm 20V, V_{DS}=0V$	I_{GSS}	---	---	± 100	nA
Zero gate voltage drain current	$V_{DS}= 100V, V_{GS}= 0V, T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	I_{DSS}	---	0.1	1	μA
On characteristics						
Drain-source on-state resistance	$V_{GS} = 10V, I_D = 100A, T_j=25^\circ\text{C}$	$R_{DS(on)}$	---	2.3	2.6	m Ω
Gate-source threshold voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(th)}$	2.0	3.0	4.0	V
Gate resistance	f = 1MHz, open drain	R_G	---	1.2	---	Ω
Dynamic and switching characteristics-						
Gate-source charge	$V_{DD} = 50V, I_D = 50A$ $V_{GS} = 0$ to 10V	Q_{gs}	---	37	---	nC
Gate-drain charge		Q_{gd}	---	30	---	
Gate charge total		Q_g	---	119	---	
Turn-on delay time	$V_{DD} = 50V, I_D = 100A$ $V_{GS} = 10V, R_{G,ext} = 1.6\Omega$	$T_{d(on)}$	---	29.2	---	ns
Rise time		T_r	---	22.6	---	
Turn-off delay time		$T_{d(off)}$	---	44	---	
Fall time		T_f	---	18.8	---	
Input capacitance	$V_{GS} = 0V, V_{DS} = 50V,$ f = 1MHz	C_{iss}	---	7600	---	pF
Output capacitance		C_{oss}	---	1310	---	
Reverse transfer capacitance		C_{rss}	---	45	---	

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Drain-source diode characteristics and maximum ratings						
Inverse diode forward voltage	$I_S = 100A, V_{GS} = 0V$	V_{SD}	---	0.9	1.2	V
Reverse recovery time	$V_R = 50V, I_F = 50A,$ $di_F / dt = 100A / \mu S$	t_{rr}	---	85	---	ns
Reverse recovery charge		Q_{rr}	---	175	---	nC
Peak reverse recovery current		I_{rm}	---	3.8	---	A

Notes:

1. Repetitive rating : pulsed width limited by maximum junction temperature.
2. $V_{DD}=50V$, starting $T_j=25^\circ\text{C}$.



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Thermal characteristics			
Thermal resistance junction-to-case	R _{thJC}	0.55	°C / W
Thermal resistance junction-to-ambient	R _{thJA}	62	

Package Marking and Ordering Information

Type / Ordering Code	Package	Packaging	Related Links
I3GT026N10	TO-220	Tube	see Package outline

Electrical characteristics diagrams

Fig 1: Power dissipation

$P_{tot} = f(T_j)$

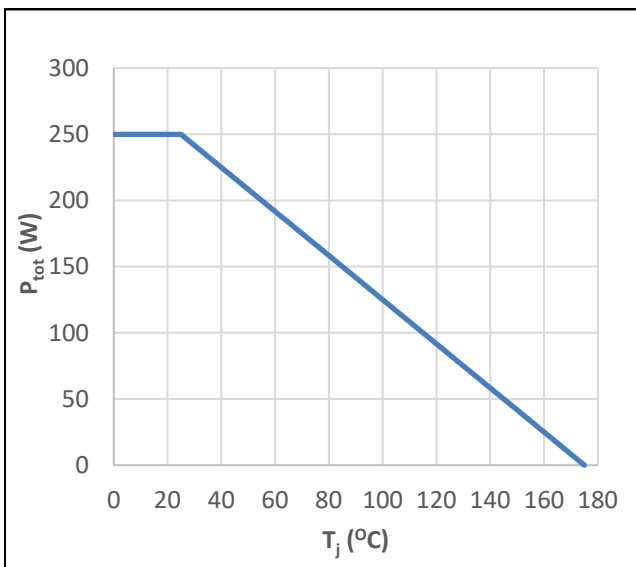
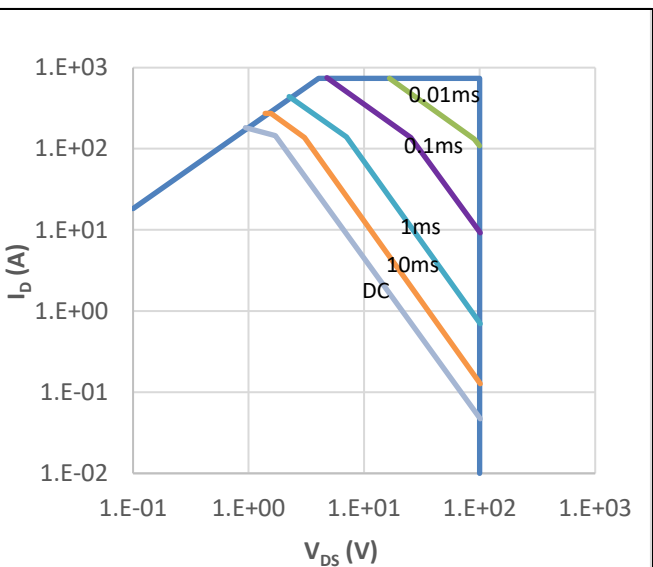


Fig 2: Safe operating area

$I_D = f(V_{DS})$; parameter : D = 0, T_C = 25°C





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Fig 3: Transient thermal impedance

$Z_{thJC} = f (tp)$; parameter : $D = tp / T$

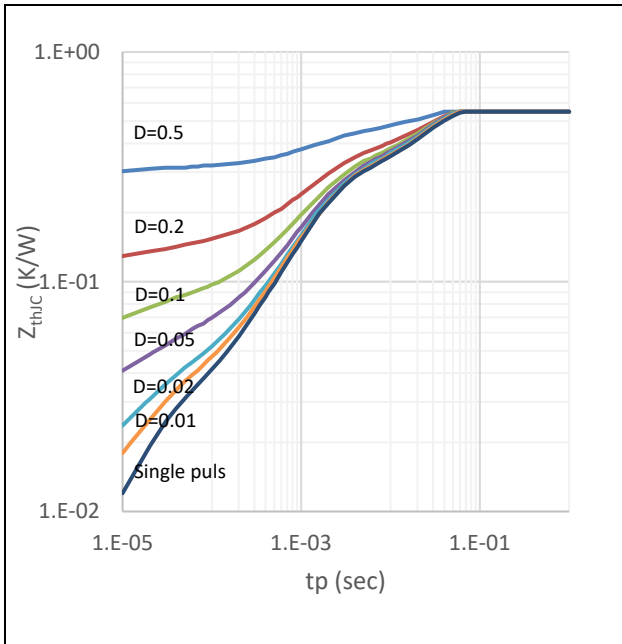


Fig 4: Typ. output characteristics

$I_D = f (V_{DS})$; $T_j = 25^{\circ}C$; parameter: V_{GS}

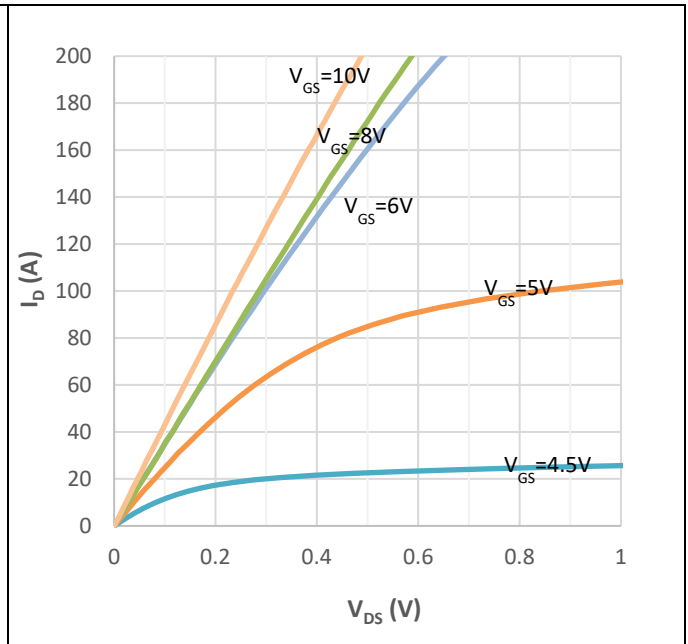


Fig 5: Drain current

$I_D = f (T_c)$; $V_{GS} \geq 10V$

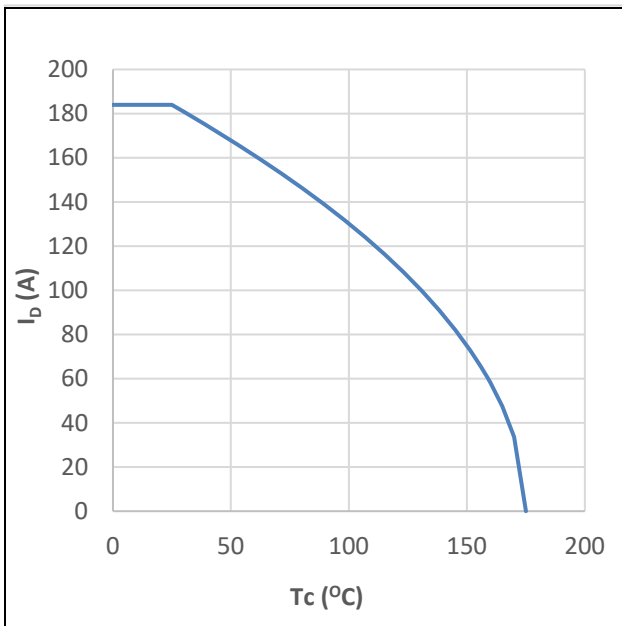
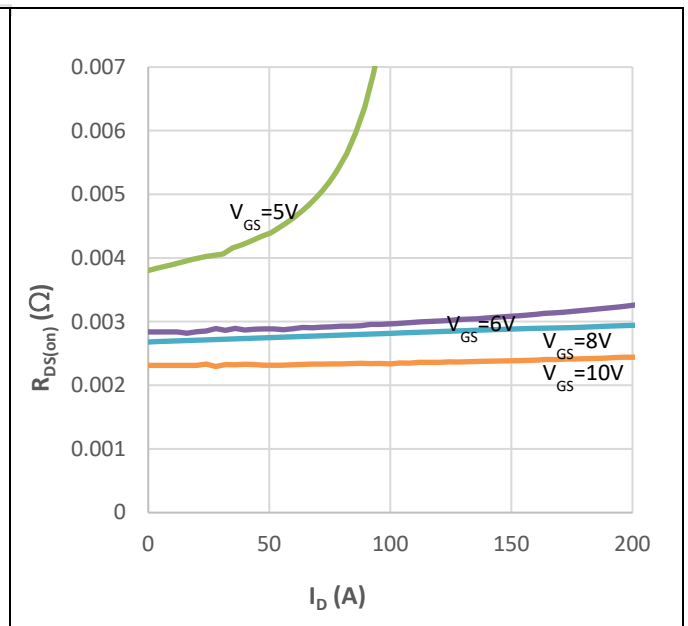


Fig 6: Typ. Drain source on-resistance

$R_{DS(on)} = f (I_D)$; parameter : $tp = 50\mu s$, $T_j = 25^{\circ}C$, V_{GS}





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Fig 7: Drain-source on-state resistance

$R_{DS(on)} = f(T_j)$; parameter: $I_D = 100A, V_{GS} = 10V$

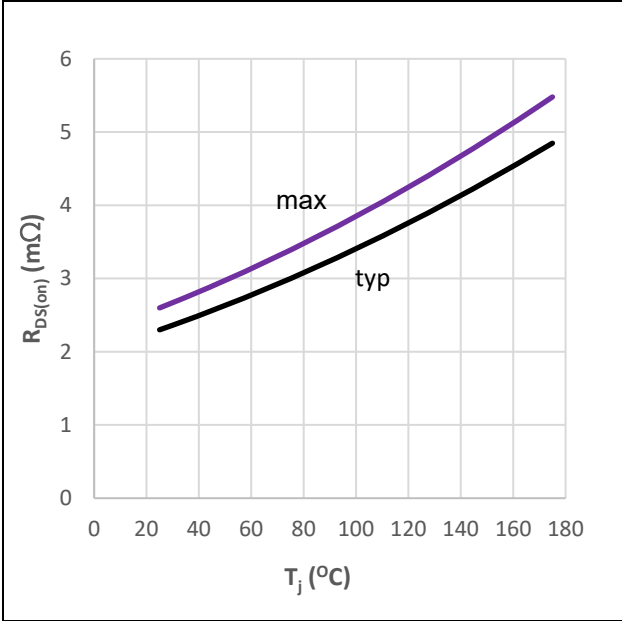


Fig 8: Typ. transfer characteristics

$I_D = f(V_{GS})$; $V_{DS} \geq 2 \times I_D \times R_{DS(on) \text{ max}}$; $T_j = 25^{\circ}C$; parameter: $t_p = 50 \mu S$

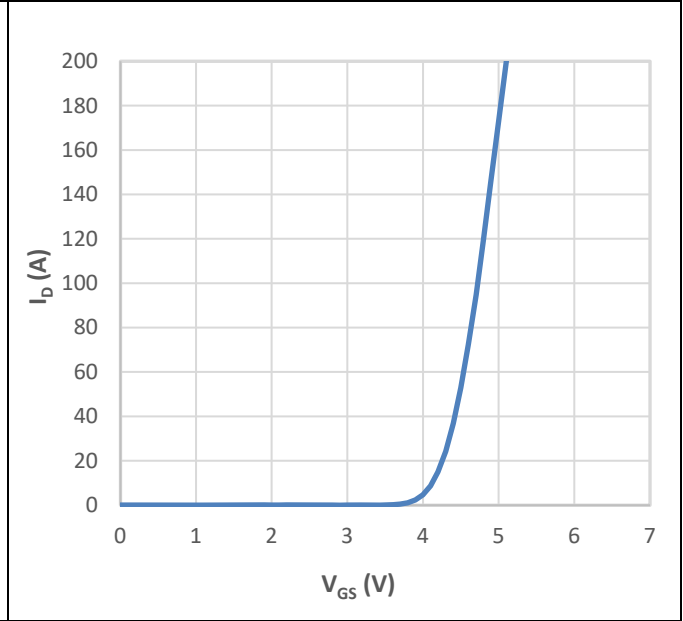


Fig 9: Typ. gate charge

$V_{GS} = f(Q_{GATE})$; $I_D = 50A$ pulsed

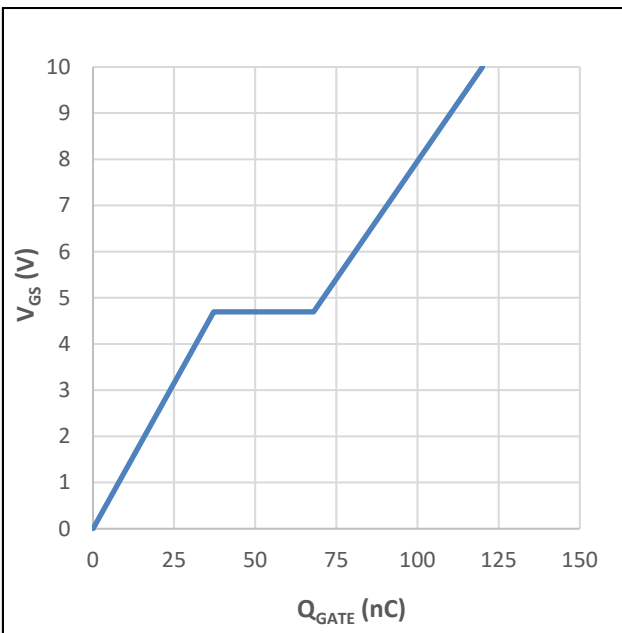
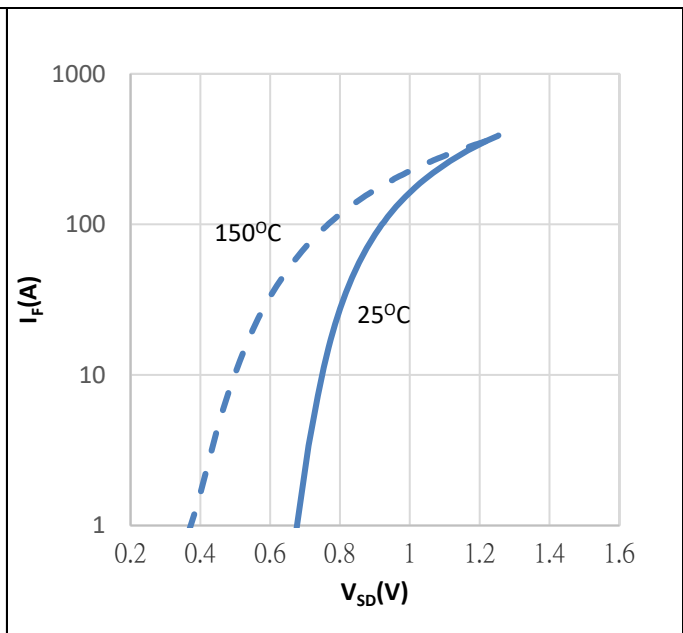


Fig 10: Forward characteristics of body diode

$I_F = f(V_{SD})$; parameter: $T_j, t_p = 20\mu S$





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Fig 11: Drain-source breakdown voltage

$BV_{DSS} = f(T_j)$

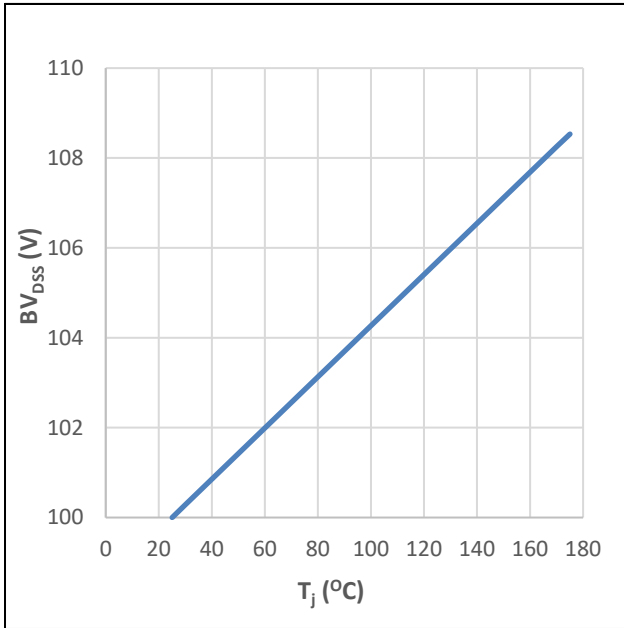


Fig 12: Typ. capacitances

$C = f(V_{DS})$; parameter : $V_{GS} = 0V, f = 1MHz$

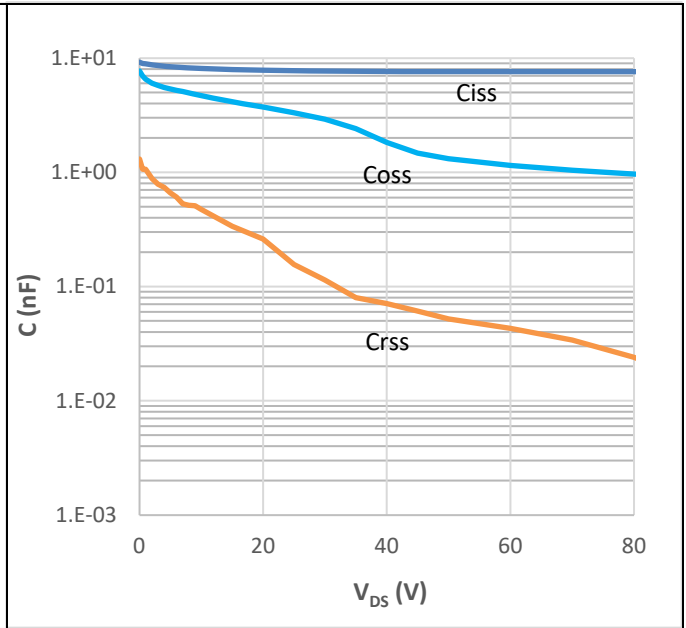
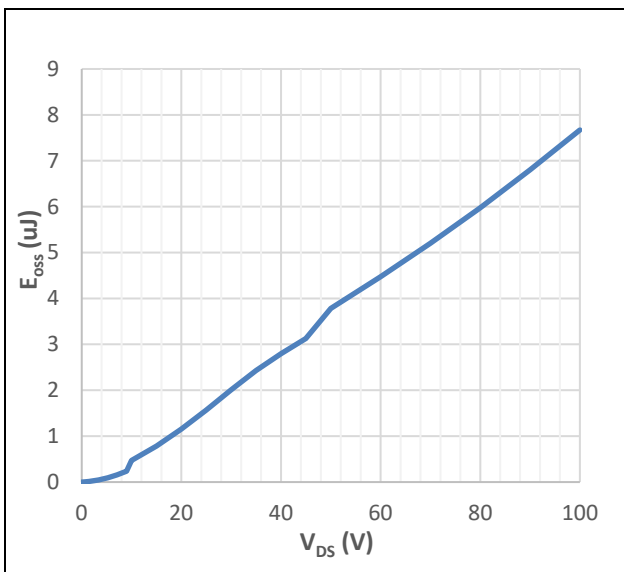


Fig 13: Typ. Coss stored energy

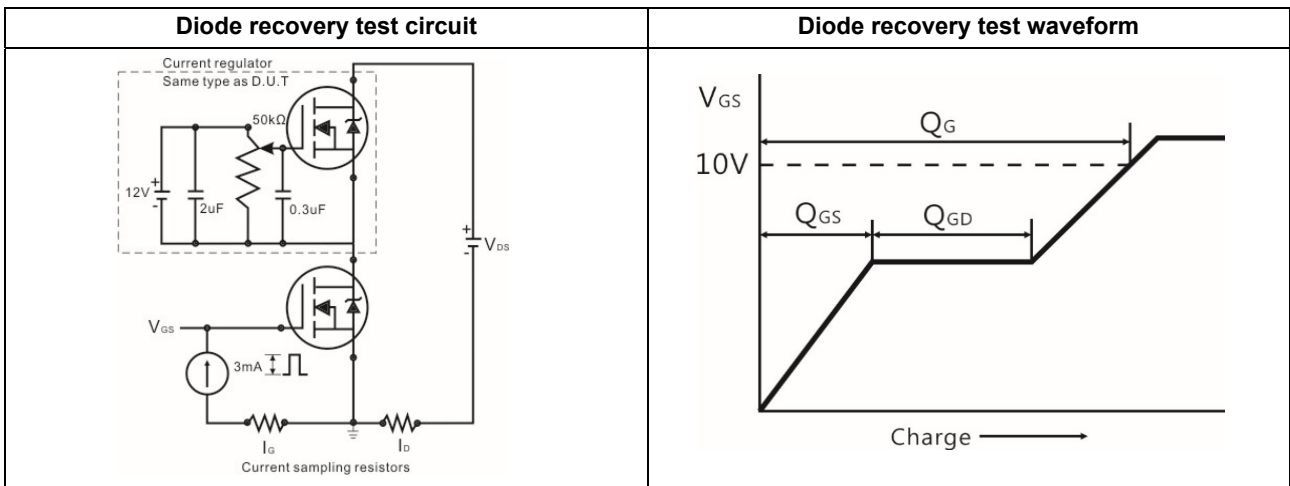
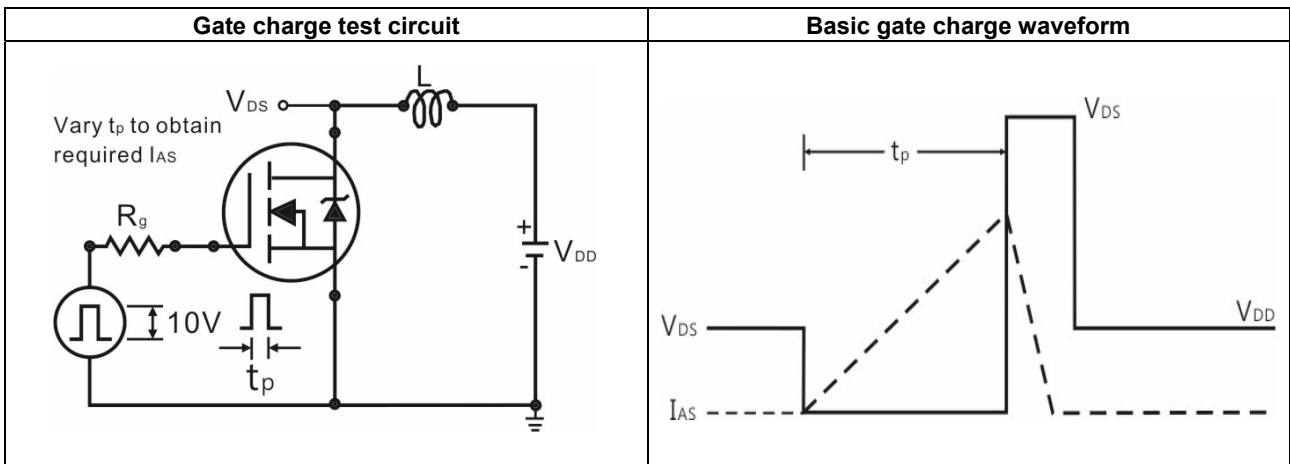
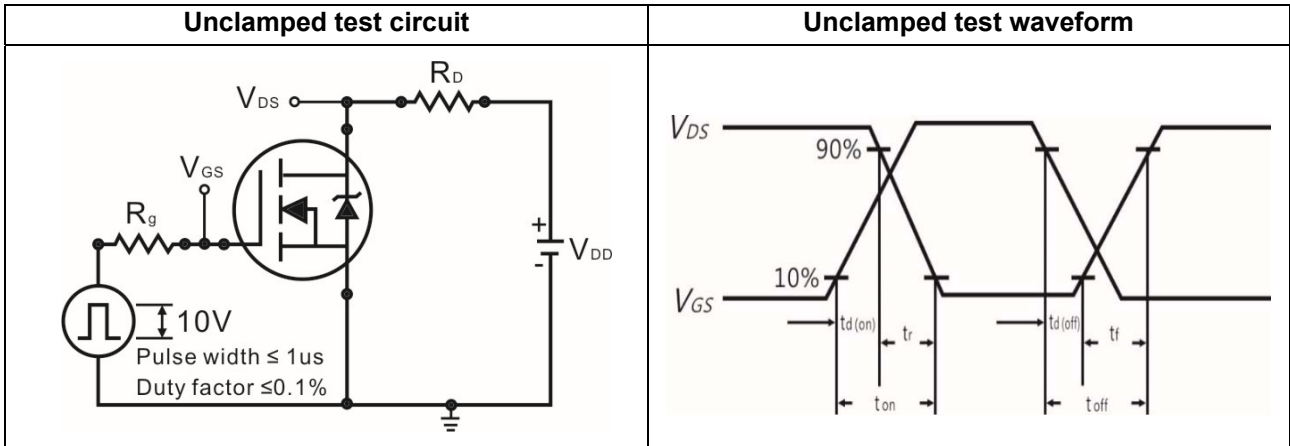
$E_{oss} = f(V_{DS})$





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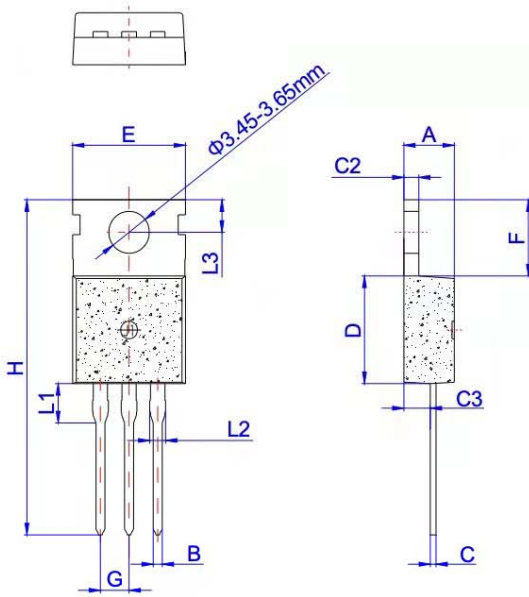
Test Circuit





Package outline

PACKAGE MECHANICAL DATA



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
Φ		3.6			0.142	

PACKAGE INFORMATION-TO-220C

OUTLINE	UNIT WEIGHT (g/PCS) typ.	TUBE (PCS)	PER CARTON (PCS)
TUBE	2.08	50	5,000